

54AC20

54AC20 Dual 4-Input NAND Gate



Literature Number: SNOS083

54AC20 Dual 4-Input NAND Gate

General Description

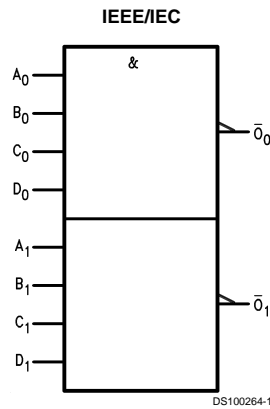
The 'AC20 contains four 4-input NAND gates.

- Outputs source/sink 24 mA
- Standard Military Drawing (SMD)
- 'AC20: 5962-87613

Features

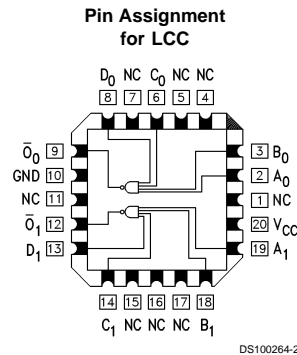
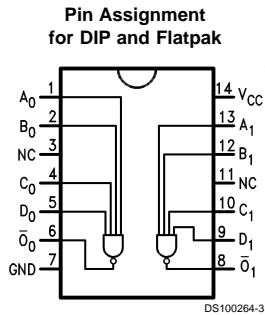
- I_{CC} reduced by 50%

Logic Symbol



Pin Names	Description
A_n, B_n, C_n, D_n	Inputs
\bar{O}_n	Outputs

Connection Diagrams



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Absolute Maximum Ratings (Note 1)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Supply Voltage (V_{CC})	-0.5V to +7.0V
DC Input Diode Current (I_{IK})	
$V_I = -0.5V$	-20 mA
$V_I = V_{CC} + 0.5V$	+20 mA
DC Input Voltage (V_I)	-0.5V to $V_{CC} + 0.5V$
DC Output Diode Current (I_{OK})	
$V_O = -0.5V$	-20 mA
$V_O = V_{CC} + 0.5V$	+20 mA
DC Output Voltage (V_O)	-0.5V to $V_{CC} + 0.5V$
DC Output Source	
or Sink Current (I_O)	±50 mA
DC V_{CC} or Ground Current	
per Output Pin (I_{CC} or I_{GND})	±50 mA
Storage Temperature (T_{STG})	-65°C to +150°C

Junction Temperature (T_J)

CDIP

175°C

Recommended Operating Conditions

Supply Voltage (V_{CC})	'AC	2.0V to 6.0V
Input Voltage (V_I)		0V to V_{CC}
Output Voltage (V_O)		0V to V_{CC}
Operating Temperature (T_A)	54AC	-55°C to +125°C
Minimum Input Edge Rate ($\Delta V/\Delta t$)	'AC Devices	
V_{IN} from 30% to 70% of V_{CC}		
V_{CC} @ 3.3V, 4.5V, 5.5V		125 mV/ns

Note 1: Absolute maximum ratings are those values beyond which damage to the device may occur. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. National does not recommend operation of FACT™ circuits outside databook specifications.

DC Characteristics for 'AC Family Devices

Symbol	Parameter	V_{CC} (V)	54AC	Units	Conditions	
			$T_A =$ -55°C to +125°C			
			Guaranteed Limits			
V_{IH}	Minimum High Level Input Voltage	3.0	2.1	V	$V_{OUT} = 0.1V$ or $V_{CC} - 0.1V$	
		4.5	3.15			
		5.5	3.85			
V_{IL}	Maximum Low Level Input Voltage	3.0	0.9	V	$V_{OUT} = 0.1V$ or $V_{CC} - 0.1V$	
		4.5	1.35			
		5.5	1.65			
V_{OH}	Minimum High Level Output Voltage	3.0	2.9	V	$I_{OUT} = -50 \mu A$	
		4.5	4.4			
		5.5	5.4			
			3.0	2.4	V	(Note 2) $V_{IN} = V_{IL}$ or V_{IH} $I_{OH} = -12 \text{ mA}$ $I_{OH} = -24 \text{ mA}$ $I_{OH} = -24 \text{ mA}$
			4.5	3.7		
			5.5	4.7		
V_{OL}	Maximum Low Level Output Voltage	3.0	0.1	V	$I_{OUT} = 50 \mu A$	
		4.5	0.1			
		5.5	0.1			
			3.0	0.5	V	(Note 2) $V_{IN} = V_{IL}$ or V_{IH} $I_{OL} = 12 \text{ mA}$ $I_{OL} = 24 \text{ mA}$ $I_{OL} = 24 \text{ mA}$
			4.5	0.5		
			5.5	0.5		
I_{IN}	Maximum Input Leakage Current	5.5	±1.0	μA	$V_I = V_{CC}, GND$	
I_{OLD}	Minimum Dynamic Output Current (Note 3)	5.5	50	mA	$V_{OLD} = 1.65V \text{ Max}$	
I_{OHD}		5.5	-50	mA	$V_{OHD} = 3.85V \text{ Min}$	

DC Characteristics for 'AC Family Devices (Continued)

Symbol	Parameter	V _{CC} (V)	54AC		Units	Conditions
			T _A = -55°C to +125°C			
			Guaranteed Limits			
I _{CC}	Maximum Quiescent Supply Current	5.5	40.0		μA	V _{IN} = V _{CC} or GND

Note 2: All outputs loaded; thresholds on input associated with output under test.

Note 3: Maximum test duration 2.0 ms, one output loaded at a time.

Note 4: I_{IN} and I_{CC} @ 3.0V are guaranteed to be less than or equal to the respective limit @ 5.5V V_{CC}.

I_{CC} for 54AC @ 25°C is identical to 74AC @ 25°C.

AC Electrical Characteristics

Symbol	Parameter	V _{CC} (V) (Note 5)	54AC		Units
			T _A = -55°C to +125°C C _L = 50 pF		
			Min	Max	
t _{PLH}	Propagation Delay	3.3	1.0	11.0	ns
		5.0	1.0	8.5	
t _{PHL}	Propagation Delay	3.3	1.0	10.0	ns
		5.0	1.0	7.0	

Note 5: Voltage Range 3.3 is 3.3V ±0.3V

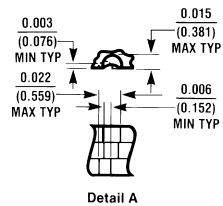
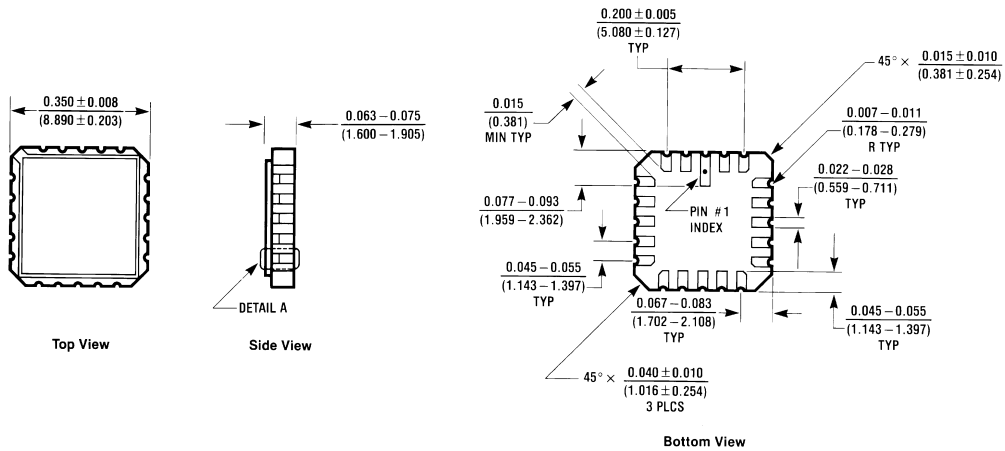
Voltage Range 5.0 is 5.0V ±0.5V

Capacitance

Symbol	Parameter	Typ	Units	Conditions
C _{IN}	Input Capacitance	4.5	pF	V _{CC} = OPEN
C _{PD}	Power Dissipation Capacitance	40.0	pF	V _{CC} = 5.0V

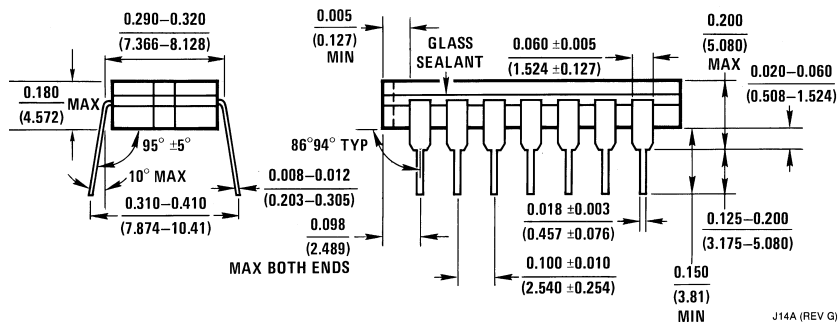
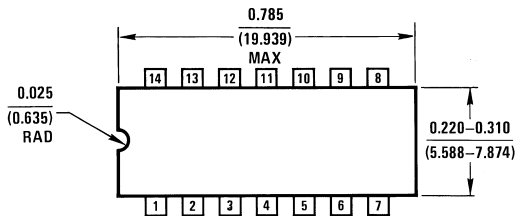


Physical Dimensions inches (millimeters) unless otherwise noted



20 Terminal Ceramic Leadless Chip Carrier (L)
 NS Package Number E20A

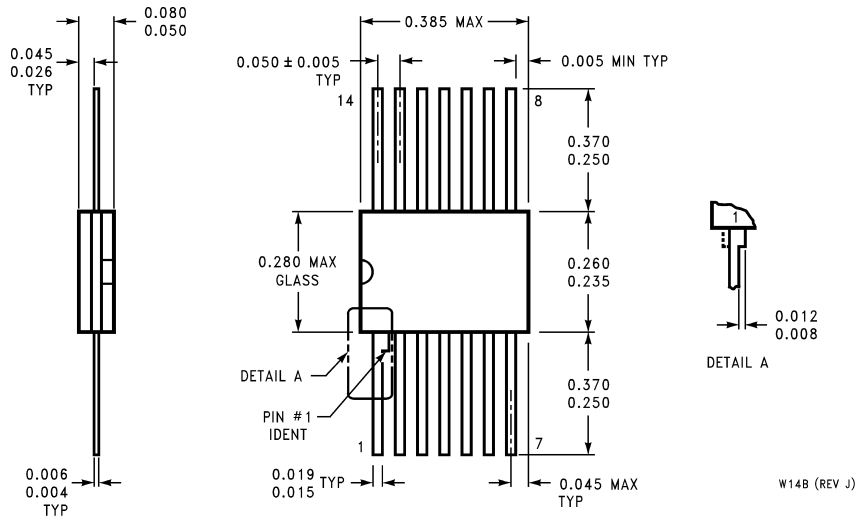
E20A (REV D)



14 Lead Ceramic Dual-In-Line Package (D)
 NS Package Number J14A

J14A (REV G)

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



**14 Lead Ceramic Flatpak (F)
NS Package Number W14B**

W14B (REV J)

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